

# **ECX-2236 SMD CRYSTAL**

Request a Sample



The miniature ECX-2236 is a compact SMD Crystal. The industry standard 2.5 x 2.0 x 0.55 mm is ideal for bluetooth, LoRa WAN, and wireless applications.

#### **ECX-2236 SMD CRYSTAL**



- Low Profile
- 2.5 x 2.0 mm Footprint
- Extended Temp. Range
- IOT/Wearable applications

### **DIMENSIONS (mm)**

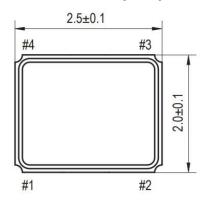


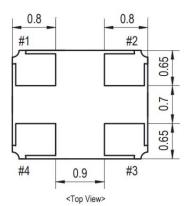


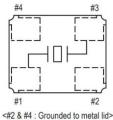
Figure 1) Top, Side, and Bottom

Crystal is symmetrical, pad 1 & 3 are interchangeable. Chamfer on the bottom pad has no electrical significance.

## **OPERATING CONDITIONS / ELECTRICAL CHARACTERISTICS**

PARAMETERS	CONDITIONS	ECX-2236		;	UNITS
		MIN	TYP	MAX	
Frequency		12.000		80.000	MHz
Mode of Oscillation	Fundamental				
Frequency Tolerance*	@ +25°C			± 50	ppm
Frequency Stability*	-20 ~ +70°C			± 50	ppm
Shunt Capacitance	Со			5	pF
Load Capacitance	Specify in P/N		8		pF
Drive Level	DL			100	μW
Operating Temperature*	Topr	-20		+70	°C
Storage Temperature	Tstg	-55		+125	°C
Aging (First Year)	@ +25°C ±3°C			±5	ppm





Pad Connections		
1	In/Out	
2	Gnd	
3	Out/In	
4	Gnd	

Frequency (MHz)	ESR Ω Max.
12.000 ~ 15.999	150
16.000 ~ 19.999	80
20.000 ~ 29.999	60
30.000 ~ 34.999	50
35.000 ~ 80.000	40

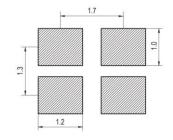


Figure 2) Suggested land

### PART NUMBERING GUIDE: Example ECS-240-8-36-TR

ECS - FI	REQUENCY ABBREVIATION	LOAD	PACKAGE		AVAILABLE OPT	IONS	PACKAGING
		CAPACITANCE		Tolerance	e Stability	Temp Range	
ECS	240 = 24.000 MHz See P/N Guide	8 = 8 pF 10=10 pF	-36 = ECX-2236	Blank = Std A = ± 25 ppm J = ± 20 ppm R = ± 15 ppm	Blank= Std D= ±100 ppm E = ± 50 ppm G = ± 30 ppm	Blank= Std L = -10 ~ +70°C M = -20 ~ +70°C Y = -30 ~ +85°C	TR =1K TR3=3K Qty/Reel
* Specify a	vailable options in P/N.			C = ± 10 ppm	H = ± 25 ppm T = ± 20 ppm †	N = -40 ~ +85°C P = -40 ~ +105°C	

 $W = \pm 15 ppm †$ 

 $K = \pm 10 ppm \dagger$ 

 $S = -40 \sim +125 °C$  $U = -55 \sim +125 °C$ 

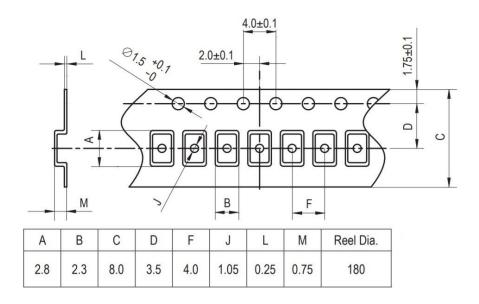
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<sup>†</sup> Contact ECS for availability over extended temp range.





### **POCKET TAPE DIMENSIONS (mm)**



SOLDER PROFILE		
Peak solder Temp +260°C Max 10 sec Max.		
2 Cycles Max.		
MSL 1, Lead Finish Au		

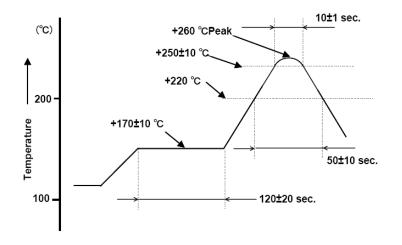


Figure 1) Suggested Reflow Profile

DEVELOPED FREQUENCIES			
Abbreviation	Frequency (MHZ)		
120	12.000		
160	16.000		
192	19.200		
200	20.000		
240	24.000		
245.7	24.576		
250	25.000		
260	26.000		
270	27.000		
300	30.000		
320	32.000		
360	36.000		
400	40.000		
480	48.000		